PD-94837

International
IOR Rectifier

SMPS MOSFET

IRFIB5N65APbF

HEXFET® Power MOSFET

V_{DSS}	$R_{DS(on)}$ max	I_D
650V	0.93Ω	5.1A

Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching
- High Voltage Isolation = 2.5KVRMS⑥
- Lead-Free

Benefits

- Low Gate Charge Qg results in Simple Drive Requirement
- Improved Gate, Avalanche and Dynamic dv/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current

TO-220 Full-Pak G D S

Absolute Maximum Ratings

	Parameter	Max.	Units
I_D @ T_C = 25°C	Continuous Drain Current, V_{GS} @ 10V	5.1	A
I_D @ T_C = 100°C	Continuous Drain Current, V_{GS} @ 10V	3.2	
I_{DM}	Pulsed Drain Current ①	21	
P_D @T_C = 25°C	Power Dissipation	60	W
	Linear Derating Factor	0.48	W/°C
V_{GS}	Gate-to-Source Voltage	± 30	V
dv/dt	Peak Diode Recovery dv/dt ③	2.8	V/ns
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 150	°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torqe, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

Typical SMPS Topologies

- Single Transistor Flyback
- Single Transistor Forward

Notes ① through ⑥are on page 8

Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	650	—	—	V	V_{GS} = 0V, I_D = 250µA
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	0.67	—	V/°C	Reference to 25°C, I_D = 1mA⑥
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	—	0.93	Ω	V_{GS} = 10V, I_D = 3.1A ④
$V_{GS(th)}$	Gate Threshold Voltage	2.0	—	4.0	V	V_{DS} = V_{GS}, I_D = 250µA
I_{DSS}	Drain-to-Source Leakage Current	—	—	25	µA	V_{DS} = 650V, V_{GS} = 0V
		—	—	250		V_{DS} = 520V, V_{GS} = 0V, T_J = 125°C
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	V_{GS} = 30V
	Gate-to-Source Reverse Leakage	—	—	-100		V_{GS} = -30V

Dynamic @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
g_{fs}	Forward Transconductance	3.9	—	—	S	V_{DS} = 50V, I_D = 3.1A
Q_g	Total Gate Charge	—	—	48	nC	I_D = 5.2A
Q_{gs}	Gate-to-Source Charge	—	—	12		V_{DS} = 400V
Q_{gd}	Gate-to-Drain ("Miller") Charge	—	—	19		V_{GS} = 10V, See Fig. 6 and 13 ④
$t_{d(on)}$	Turn-On Delay Time	—	14	—	ns	V_{DD} = 325V
t_r	Rise Time	—	20	—		I_D = 5.2A
$t_{d(off)}$	Turn-Off Delay Time	—	34	—		R_G = 9.1Ω
t_f	Fall Time	—	18	—		R_D = 62Ω,See Fig. 10 ④
C_{iss}	Input Capacitance	—	1417	—	pF	V_{GS} = 0V
C_{oss}	Output Capacitance	—	177	—		V_{DS} = 25V
C_{rss}	Reverse Transfer Capacitance	—	7.0	—		f = 1.0MHz, See Fig. 5
C_{oss}	Output Capacitance	—	1912	—		V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz
C_{oss}	Output Capacitance	—	48	—		V_{GS} = 0V, V_{DS} = 520V, f = 1.0MHz
C_{oss} eff.	Effective Output Capacitance	—	84	—		V_{GS} = 0V, V_{DS} = 0V to 520V ⑤

Avalanche Characteristics

	Parameter	Typ.	Max.	Units
E_{AS}	Single Pulse Avalanche Energy②	—	325	mJ
I_{AR}	Avalanche Current①	—	5.2	A
E_{AR}	Repetitive Avalanche Energy①	—	6	mJ

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	2.1	°C/W
$R_{\theta JA}$	Junction-to-Ambient	—	65	

Diode Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_S	Continuous Source Current (Body Diode)	—	—	5.2	A	MOSFET symbol showing the integral reverse p-n junction diode.
I_{SM}	Pulsed Source Current (Body Diode) ①	—	—	21		
V_{SD}	Diode Forward Voltage	—	—	1.5	V	T_J = 25°C, I_S = 5.2A, V_{GS} = 0V ④
t_{rr}	Reverse Recovery Time	—	493	739	ns	T_J = 25°C, I_F = 5.2A
Q_{rr}	Reverse RecoveryCharge	—	2.1	3.2	µC	di/dt = 100A/µs ④
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by L_S+L_D)				

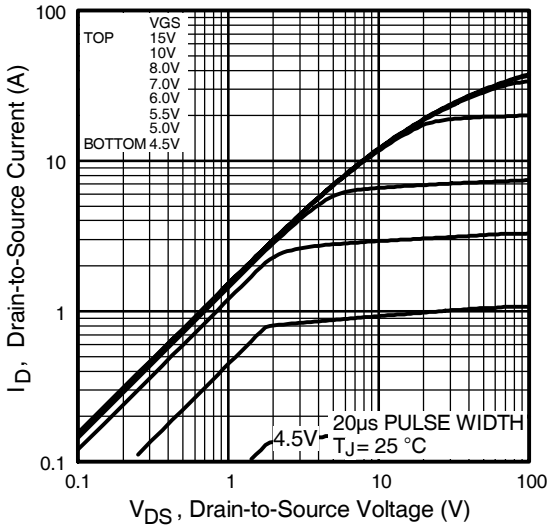

Fig 1. Typical Output Characteristics

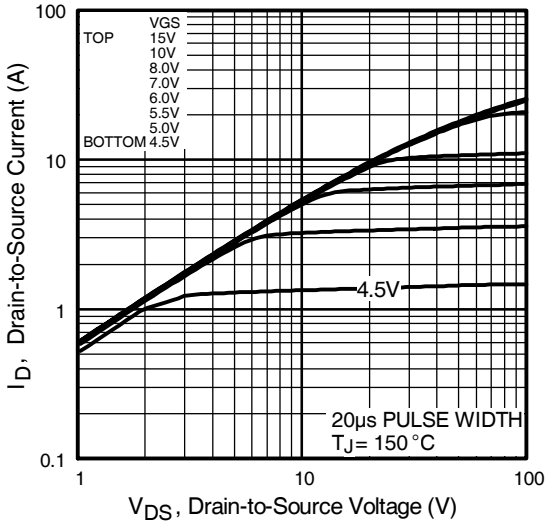

Fig 2. Typical Output Characteristics

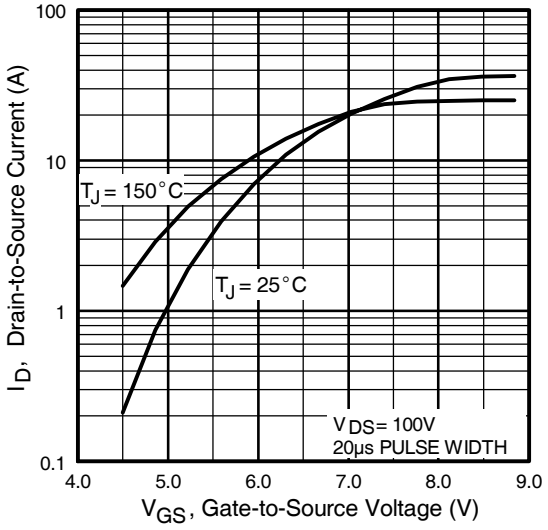

Fig 3. Typical Transfer Characteristics

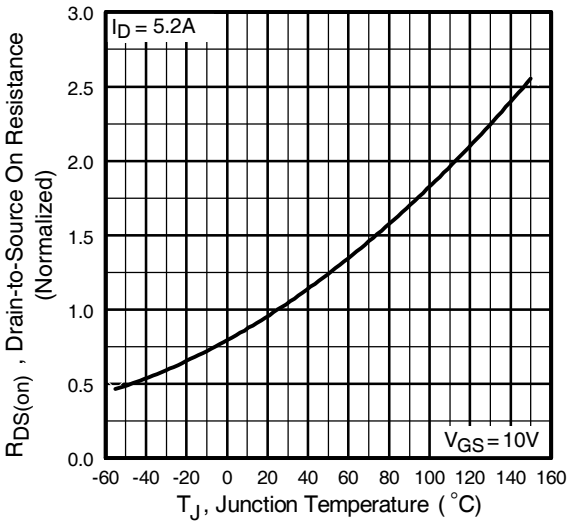

Fig 4. Normalized On-Resistance Vs. Temperature

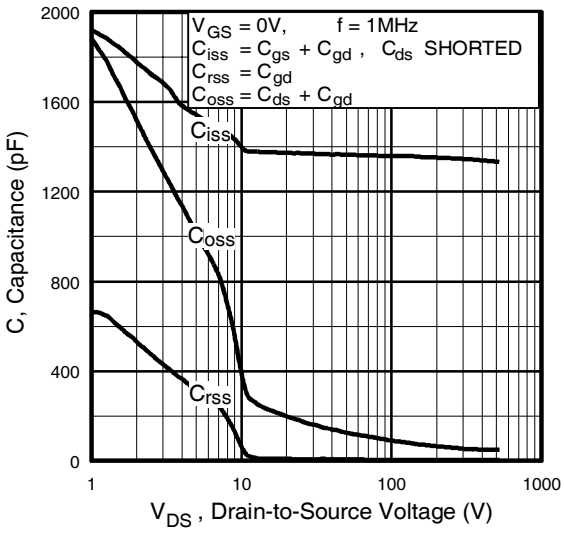

Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

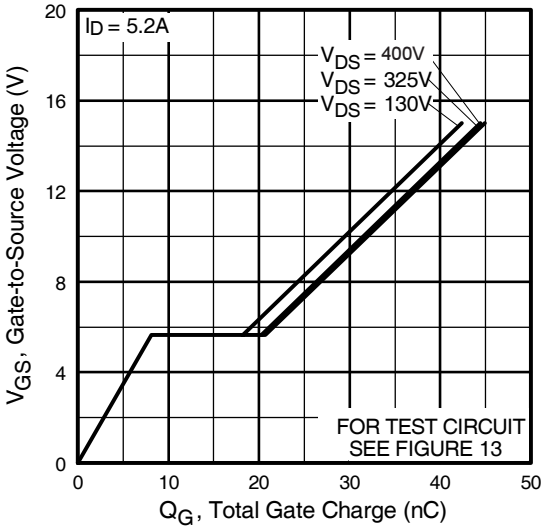

Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

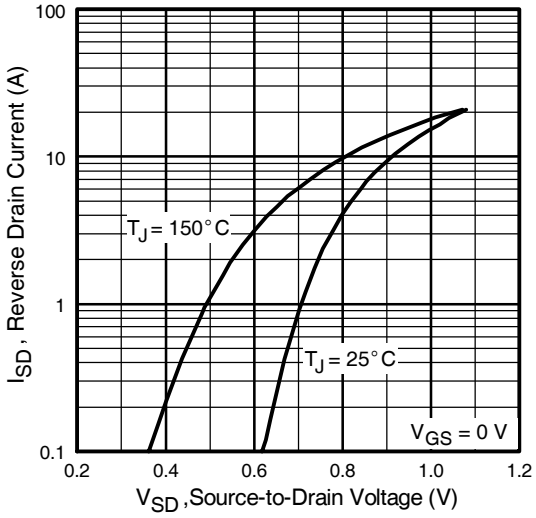

Fig 7. Typical Source-Drain Diode Forward Voltage

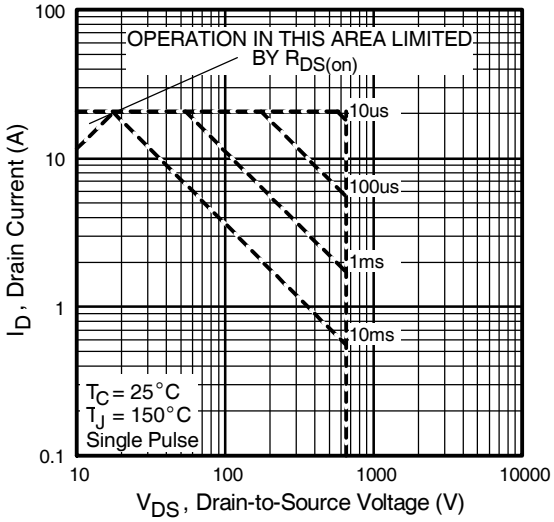

Fig 8. Maximum Safe Operating Area

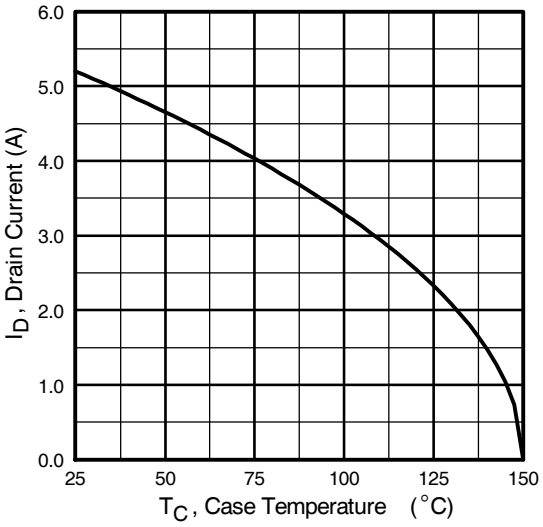

Fig 9. Maximum Drain Current Vs. Case Temperature

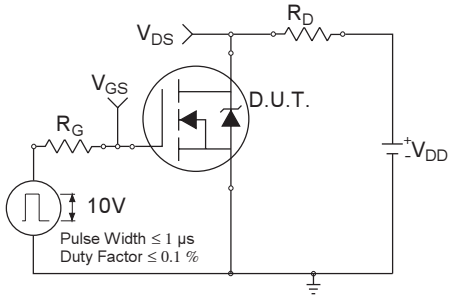

Fig 10a. Switching Time Test Circuit

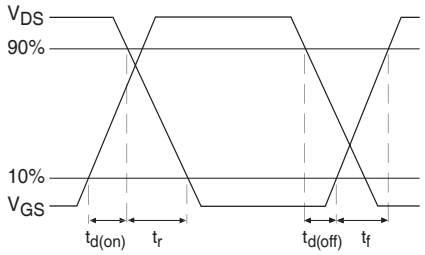

Fig 10b. Switching Time Waveforms

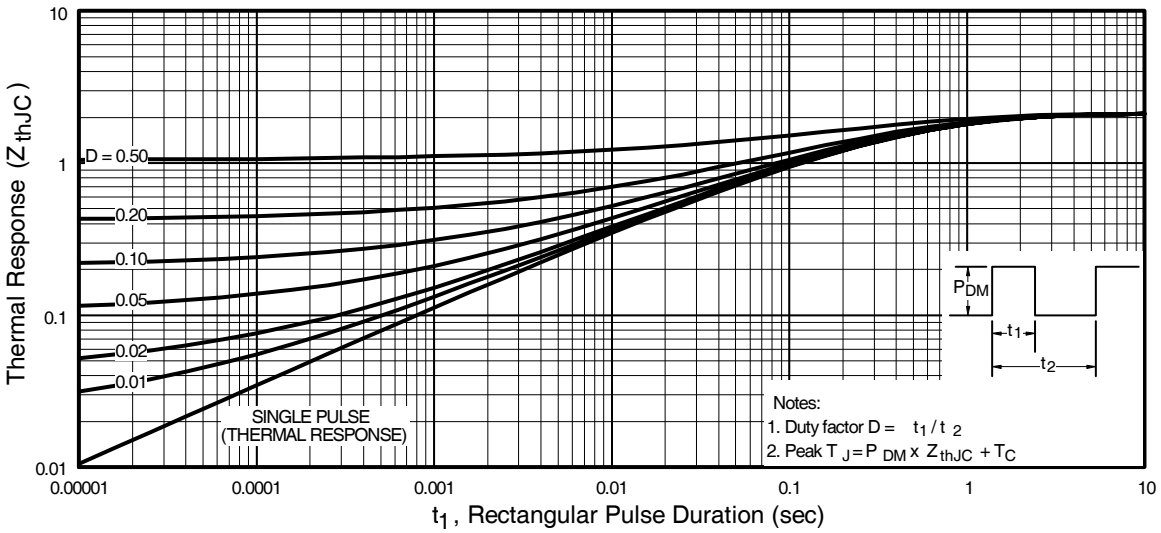

Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

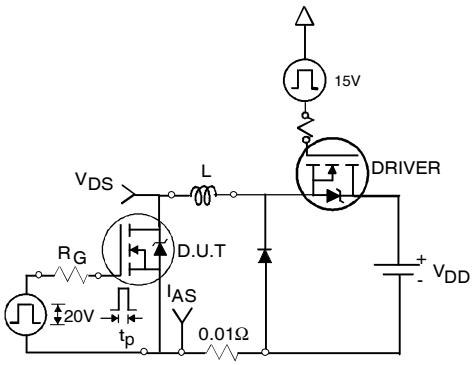

Fig 12a. Unclamped Inductive Test Circuit

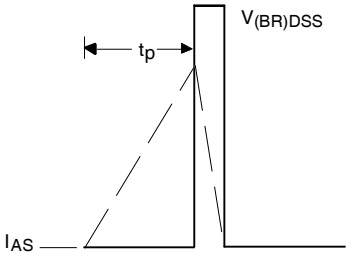

Fig 12b. Unclamped Inductive Waveforms

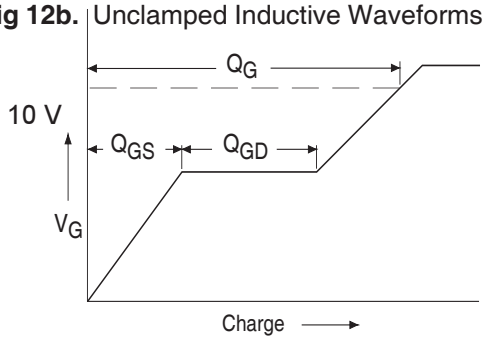

Fig 13a. Basic Gate Charge Waveform

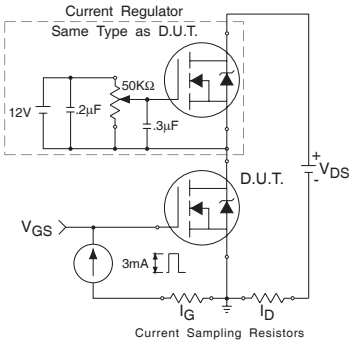

Fig 13b. Gate Charge Test Circuit

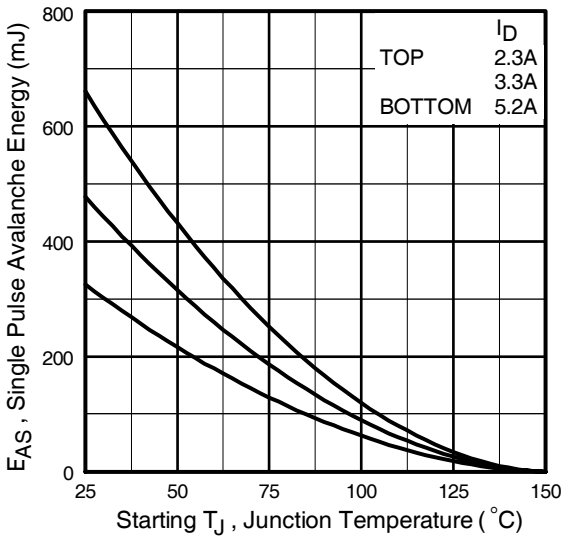

Fig 12c. Maximum Avalanche Energy Vs. Drain Current

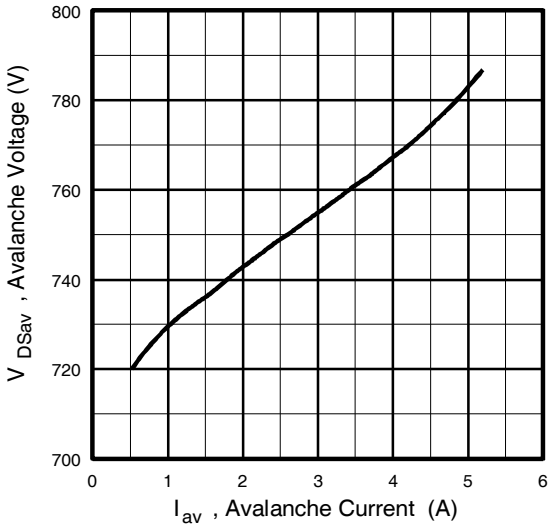

Fig 12d. Typical Drain-to-Source Voltage Vs. Avalanche Current

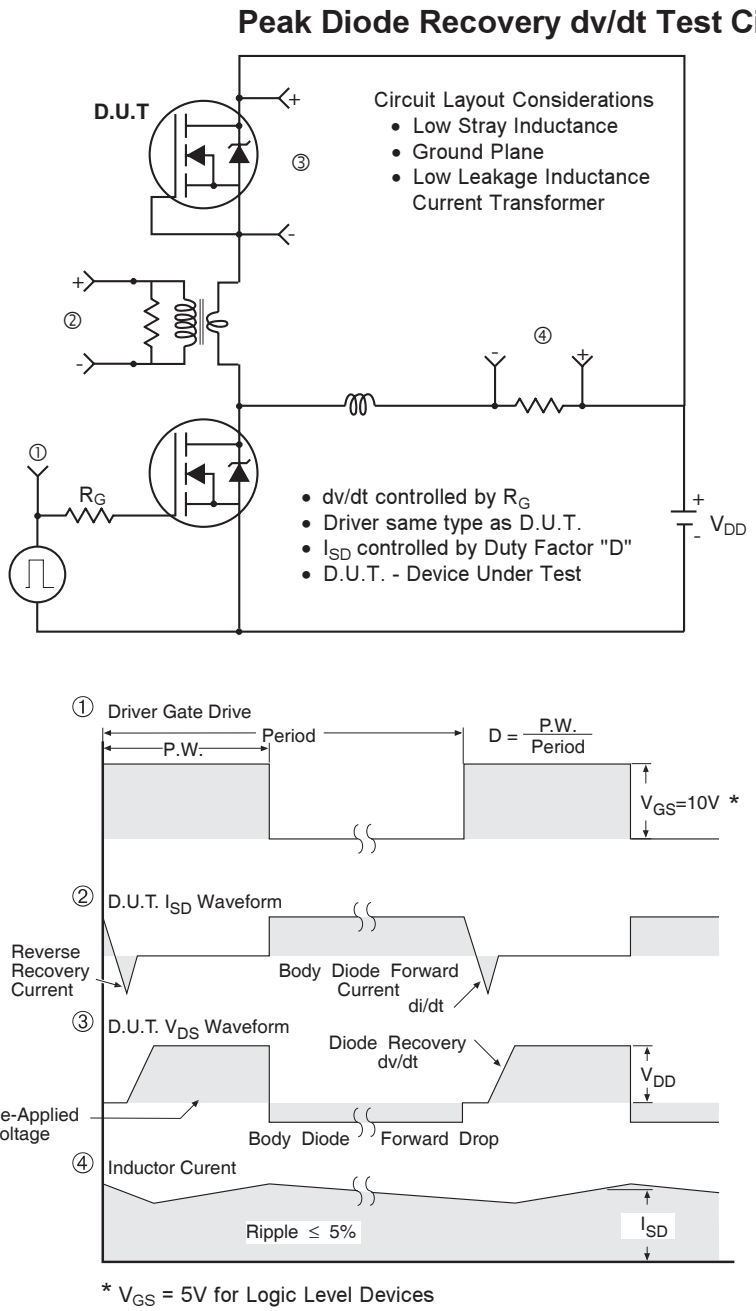

Fig 14. For N-Channel HEXFET® Power MOSFETs

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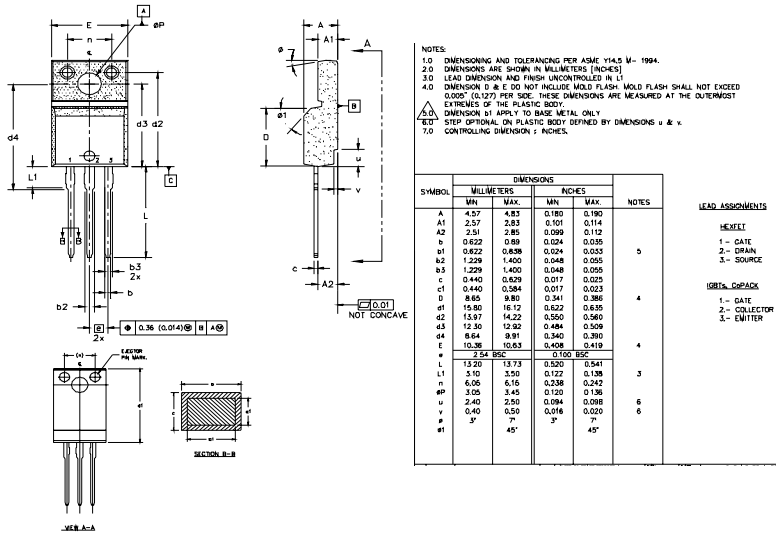
TO-220 Full-Pak Package Outline

Dimensions are shown in millimeters (inches)

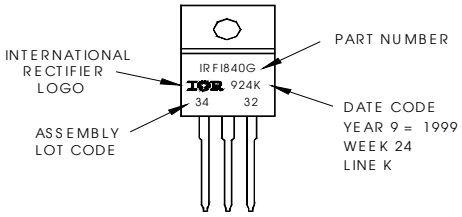


SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.57	4.83	0.180	0.190	
A1	2.57	2.83	0.101	0.114	
A2	2.51	2.85	0.099	0.112	
b	0.622	0.89	0.024	0.035	
b1	0.622	0.838	0.024	0.033	5
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
c	0.440	0.629	0.017	0.025	
c1	0.440	0.584	0.017	0.023	
D	8.65	9.80	0.341	0.386	4
d1	15.80	16.12	0.622	0.635	
d2	13.97	14.22	0.550	0.560	
d3	12.50	12.92	0.484	0.509	
d4	8.64	8.91	0.340	0.350	
E	10.36	10.63	0.408	0.419	4
e	2.54 BSC		0.100 BSC		
L	13.20	13.73	0.520	0.541	
L1	3.10	3.50	0.122	0.138	3
n	6.05	6.15	0.238	0.242	
øP	3.05	3.45	0.120	0.136	
u	2.40	2.50	0.094	0.098	6
v	0.40	0.50	0.016	0.020	6
ø	3°	7°	3°	7°	
ø1		45°		45°	

TO-220 Full-Pak Part Marking Information

EXAMPLE: THIS IS AN IRFI840G
WITH ASSEMBLY
LOT CODE 3432
ASSEMBLED ON WW 24 1999
IN THE ASSEMBLY LINE "K"

Note: "P" in assembly line position indicates "Lead-Free"



Notes:

① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)

② Starting T_J = 25°C, L = 24mH
R_G = 25Ω, I_{AS} = 5.2A. (See Figure 12)

③ $I_{SD} \leq$ 5.2A, di/dt ≤ 90A/µs, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq$ 150°C

④ Pulse width ≤ 300µs; duty cycle ≤ 2%.

⑤ C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}

⑥ t=60s, f=60Hz

Data and specifications subject to change without notice.

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11/03

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